8-Channel Analog Multiplexer Demultiplexer

HITACHI

Description

This device connects together the outputs of 8 switches, thus achieving an 8 Channel Multiplexer. The binary code placed on the A, B, and C select lines determine which one of the eight switches in "on", and connects one of the eight inputs to the common output.

Features

- High Speed Operation
- Wide Operating Voltage
- Low Quiescent Supply Current

Function Table

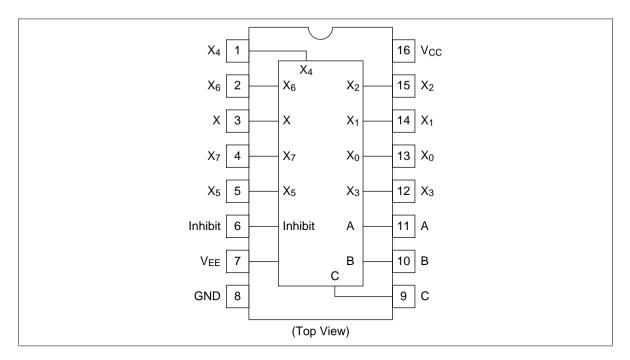
Control Inputs

Inhibit	С	В	Α	ON Switch
L	L	L	L	X ₀
L	L	L	Н	X ₁
L	L	Н	L	X ₂
L	L	Н	Н	X ₃
L	Н	L	L	X ₄
L	Н	L	Н	X ₅
L	Н	Н	L	X ₆
L	Н	Н	Н	X ₇
Н	Х	Х	Х	_
	<u>^</u>			

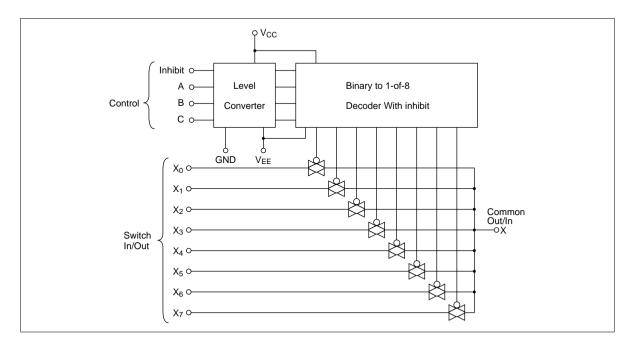
X : Don't Care



Pin Arrangement



Block Diagram



Absolute Maximum Ratings

Item		Symbol	Rating	Unit
Supply voltage		V _{cc}	–0.5 to +7.0	V
		$V_{\rm CC} - V_{\rm EE}$	-0.5 to +7.0	V
Control input voltage		V _{IN}	GND – 0.5 to V _{cc} + 0.5	V
Switch I/O voltage		V _{I/O}	V_{EE} – 0.5 to V_{CC} + 0.5	V
Supply current	(V _{cc})	I _{cc}	+50	mA
	(GND)	I _{GND}	-50	mA
Switch I/O current (per pin)		I _{1/O}	±25	mA
Control input diode current		Ι _{ικ}	±20	mA
Switch I/O diode current		I _{IOK}	±20	mA
Power dissipation		P _T	500	mW
Storage temperature range		Tstg	-65 to +150	°C

Recommended Operating Range

ltem		Symbol	Min	Тур	Max	Unit	
Supply voltage	$V_{\rm CC} - V_{\rm EE}$	2		6	V		
		$\rm V_{GND} - \rm V_{EE}$	-4	—	0	V	
Control input voltage	V _{IN}	0	_	V_{cc}	V		
Switch I/O voltage	V _{I/O}	V_{EE}	—	V_{cc}	V		
Operating temperature		Topr	-40	_	+85	°C	
Input rise/fall time	$V_{cc} = 2.0 V$	t _r , t _f	0	_	1000	ns	
	$V_{cc} = 4.5 V$		0	—	500	ns	
	$V_{cc} = 6.0 V$		0		400	ns	

DC Characteristics ($V_{SS} = V_{EE} = GND$)

			Ta = 2	25°C		Ta = · +85°0	–40 to C		
Item	Symbol	V_{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Control input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V	
		4.5	3.15	_	_	3.15	_		
		6.0	4.2		_	4.2		_	
	V _{IL}	2.0	—	—	0.5	—	0.5	V	
		4.5	—		1.35	—	1.35	_	
		6.0	—		1.8	—	1.8	_	
ON resistance	R _{on}	2.0	—	2000	5000	—	6250	Ω	$V_{INH} = V_{IL}$
		4.5	—	120	180	—	225	_	$V_{I/O} = V_{CC}$ to V_{EE}
		6.0	—	100	170	—	210	_	$I_{I/O} \le 2 \text{ mA}$
		2.0	_	200	800	_	1000	Ω	$V_{INH} = V_{IL}$
		4.5	_	80	150	_	190	_	$V_{I/O} = V_{CC}$ to V_{EE}
		6.0	—	70	140	—	175	_	$V_{I/O} \le 2 \text{ mA}$
ΔON resistance	$\Delta R_{\rm ON}$	2.0	—	50	_	—	_	Ω	$V_{INH} = V_{IL}$
between any two		4.5	—	13	40	—	50	_	$V_{I/O} = V_{CC}$ to V_{EE}
channels		6.0	—	10	20	—	25	_	$I_{I/O} \le 2 \text{ mA}$
OFF channel leakage current (switch off)	I _{S (OFF)}	6.0	_	—	±0.1	_	±1.0	μA	$V_{\rm INH} = V_{\rm IL}$
OFF channel leakage current (switch on)	I _{S (ON)}	6.0	_	_	±0.1	_	±1.0	μA	$V_{\rm INH} = V_{\rm IL}$
Control input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	$Vin = V_{cc} \text{ or } V_{ss}$
Quiescent supply current	I _{cc}	6.0	_	—	4.0	_	40	μΑ	Vin = V_{cc} or V_{ss}

AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$, $V_{SS} = V_{EE} = \text{GND}$)

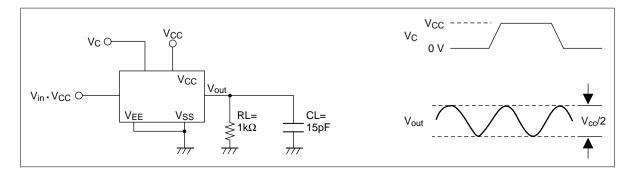
			Ta =	25°C		Ta = +85°(–40 to C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PLH}	2.0	—	25	60		75	ns	$R_{L} = 10 \text{ k}\Omega$
time		4.5	—	6	12	—	15	_	Switch input to
		6.0	—	5	10	—	13	_	switch output
	t _{PHL}	2.0	—	25	60	_	75	ns	_
		4.5	—	6	12	—	15	_	
		6.0	—	5	10	—	13	_	
Propagation delay	t _{PLH}	2.0	—	50	153	_	191	ns	$R_L = 10 \text{ k}\Omega$
time		4.5	—	16	30	_	38	_	Control input to
		6.0	—	14	26		33		switch output
	t _{PHL}	2.0	—	50	153	_	191	ns	_
		4.5	—	16	30		38		
		6.0	_	14	26	_	33	_	
Output enable	t _{zH}	2.0	_	50	153	_	191	ns	$R_{L} = 1 \ k\Omega$
time		4.5	_	14	30		38		
		6.0	_	12	26	_	33	_	
	t _{zL}	2.0	_	50	153	_	191	ns	_
		4.5	—	14	30	_	38	_	
		6.0	—	12	26		33		
Output disable	$t_{\rm HZ}$	2.0	—	40	153	_	191	ns	$R_{L} = 1 \ k\Omega$
time		4.5	—	17	30	_	38	_	
		6.0	—	14	26	_	33	_	
	t _{LZ}	2.0	—	40	153	_	191	ns	_
		4.5	_	17	30	_	38	_	
		6.0	—	14	26		33		
Control input capacitance	Cin	—	_	5	10		10	pF	
Switch input capacitance	Cin	5.0	_	5	—	_	—	pF	
Output capacitance (Common pin)	Cout	5.0	—	22	—	—	—	рF	
Feed through capacitance	Cin-out	5.0	_	0.7	—	—	—	pF	
Power dissipation capacitance	C_{PD}	5.0	—	22.0	—	—	—	рF	

AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$, $V_{SS} = V_{EE} = \text{GND}$) (cont)

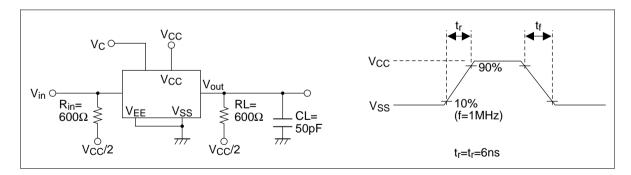
			Ta =	25°C		Ta = +85°0	–40 to C		
ltem	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Sine wave distortion		4.5	_	0.1	_	_	_	%	$ f_{in} = 1 \text{ kHz}, \text{ Vin} = 4 \text{ V}_{\text{P-P}} \\ R_{\text{L}} = 10 \text{ k}\Omega, \text{ C}_{\text{L}} = 50 \text{ pF} $
Frequency response channel "ON" (Sine wave input)		4.5	_	95	_	_	_	MHz	
Feed through attenuation		4.5	—	-50	—	—	—	dB	$\label{eq:relation} \begin{split} R_{L} &= 600 \ \Omega, \ C_{L} = 50 \ p\text{F}, \\ f_{\text{in}} &= 1 \ \text{MHz} \end{split}$
Cross talk between		2.0	—	25	—	—	—	mV	$R_{\scriptscriptstyle L}$ = 600 Ω , $C_{\scriptscriptstyle L}$ = 15 pF,
any two switches		4.5	—	60		—	—		$f_{in} = 1 MHz$
		6.0	—	75		_	—	_	
Maximum control		2.0	_	20	_	_	_	MHz	$R_{L} = 1 \text{ k}\Omega, C_{L} = 15 \text{ pF}$
frequency		4.5	_	30		_	_	_	Vout = $1/2$ (V _{cc})
		6.0	—	30	—	—	—		

AC Characteristics Test Circuit

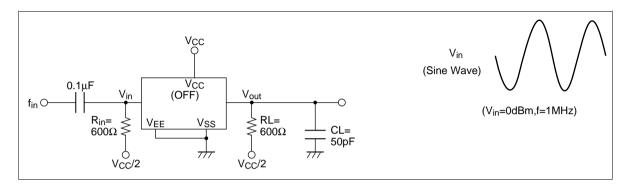
Maximum Control Frequency



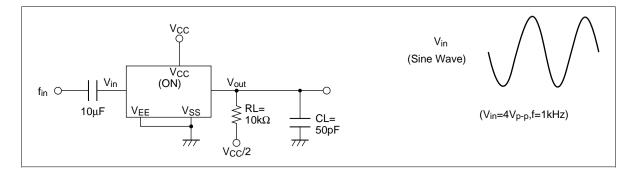
Cross talk (Control Input to Switch Output)



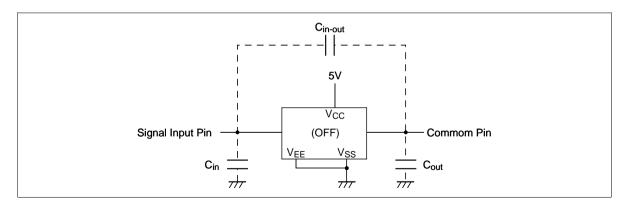
Feed through Attenuation



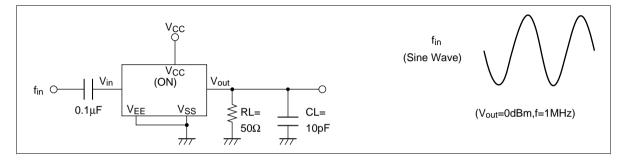
Sine Wave Distortion



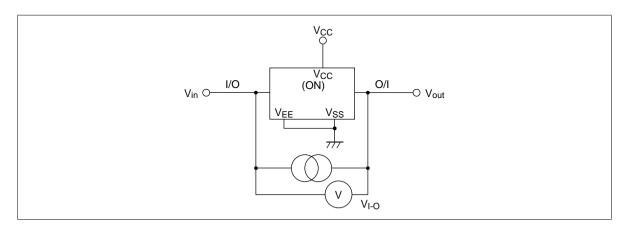
Cin, Cout, Cin–out (Input, Output, and Feed through Capacitance)



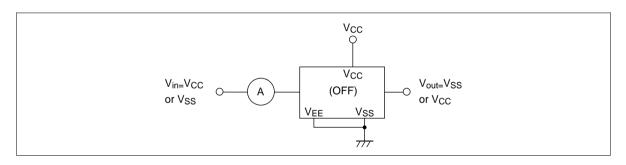
Frequency Response Channel ON



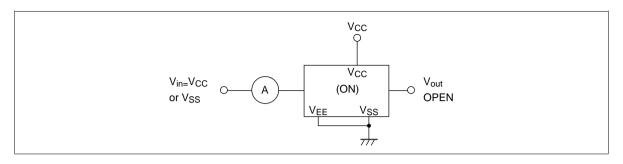
R_{ON}: ON Resistance



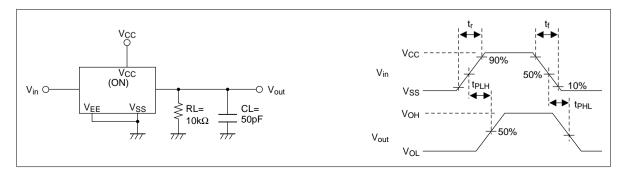
Is (OFF): OFF Channel Leakage Current (Switch OFF)



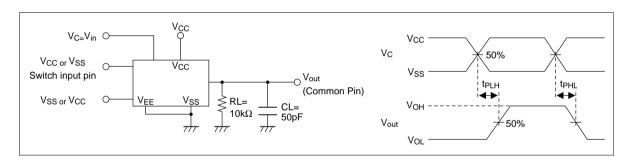
Is (ON): OFF Channel Leakage Current (Switch ON)

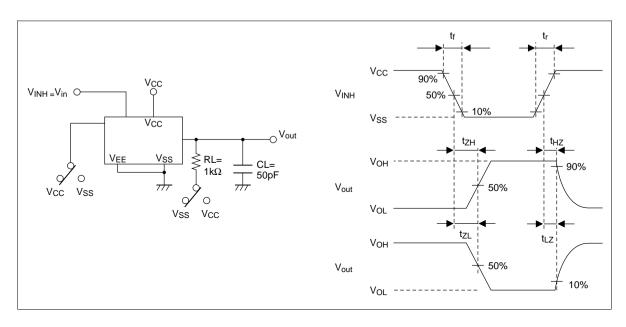


t_{PLH}, t_{PHL}: Propagation Delay Time (Switch Input to Switch Output)

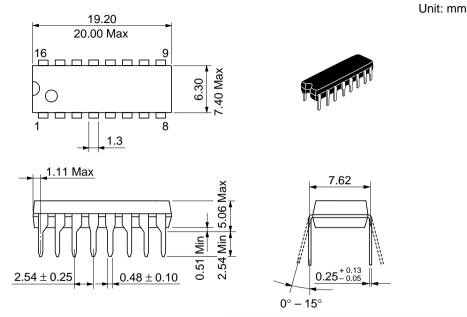


t_{PLH}, t_{PHL}: Propagation Delay Time (Control Input to Switch Output)



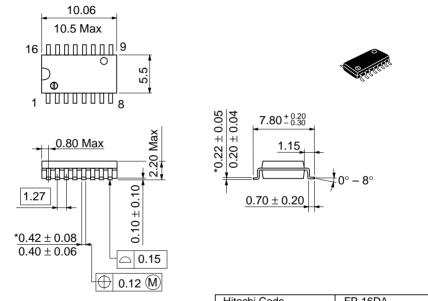


 t_{ZH} , t_{ZL}/t_{HZ} , t_{LZ} : Output Enable and Disable Time



Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g

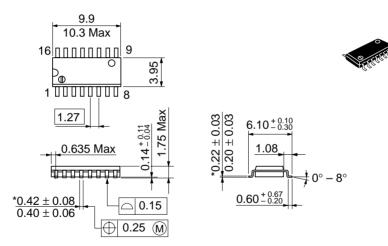
Unit: mm



*Dimension including the plating thickness Base material dimension

Hitachi Code	FP-16DA
JEDEC	
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm



*Dimension including the plating thickness Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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